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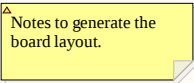
Sheet 6: SENSING

Legend

General comment such as function title, configuration, ...

Text to be added to silkscreen.

Warning text.



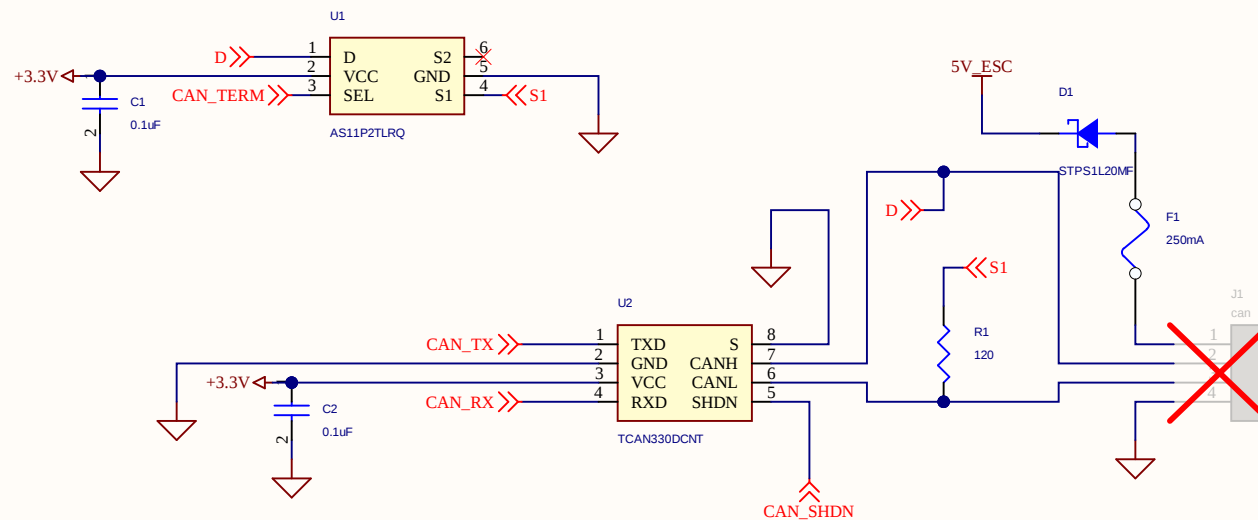
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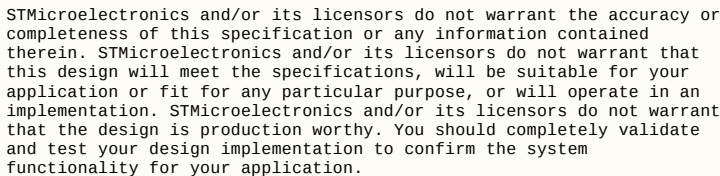
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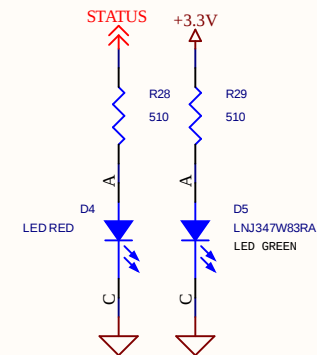
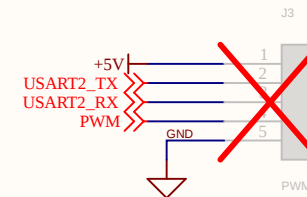
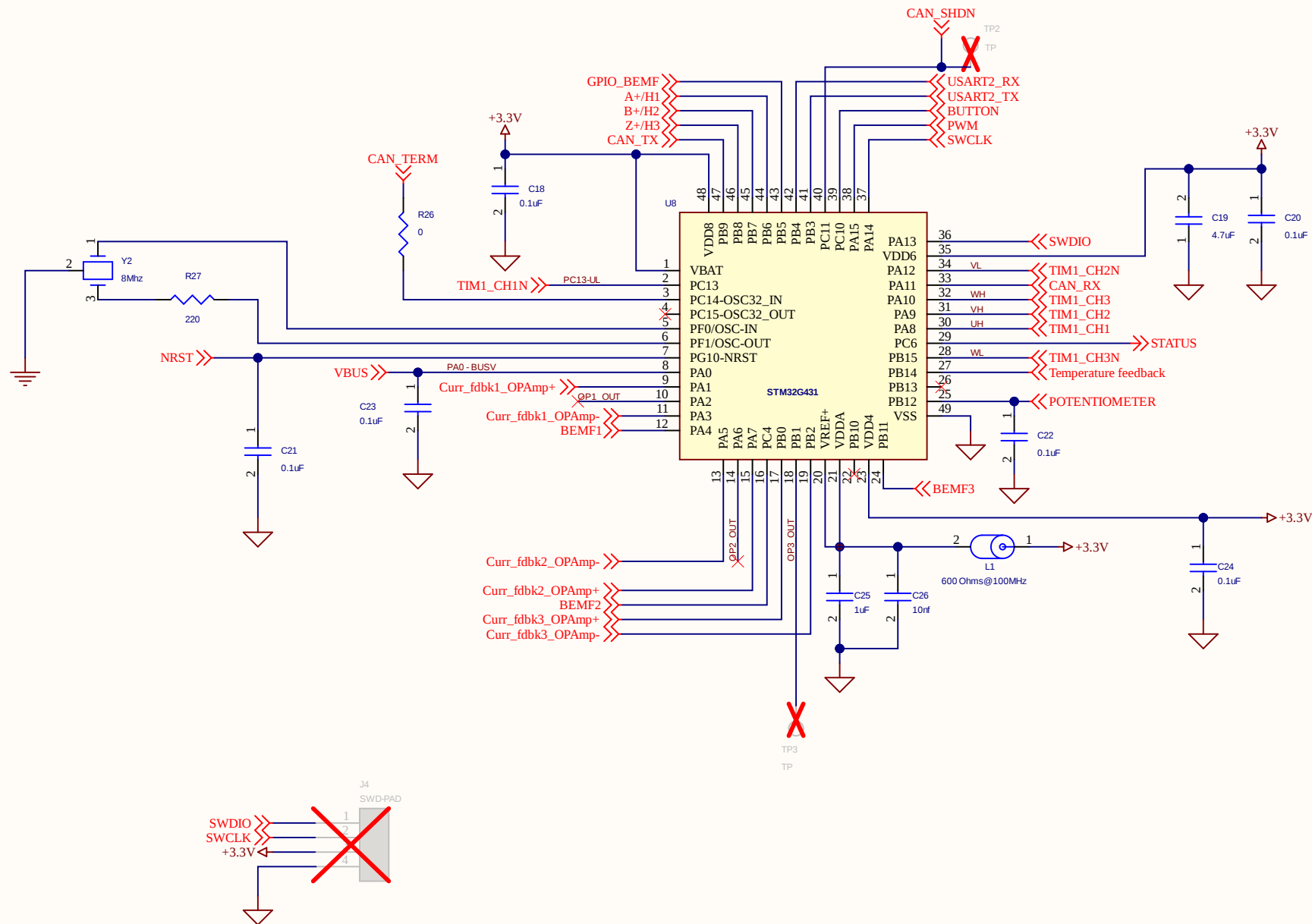




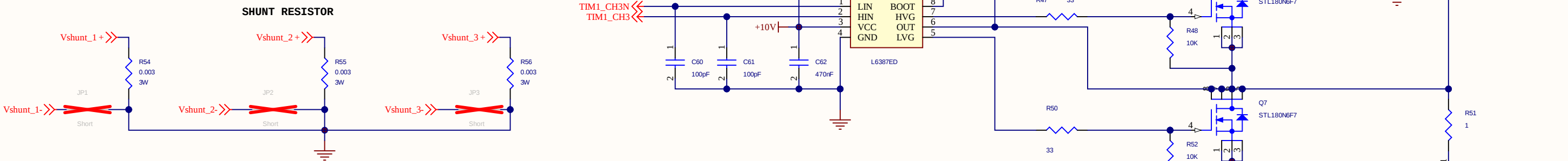
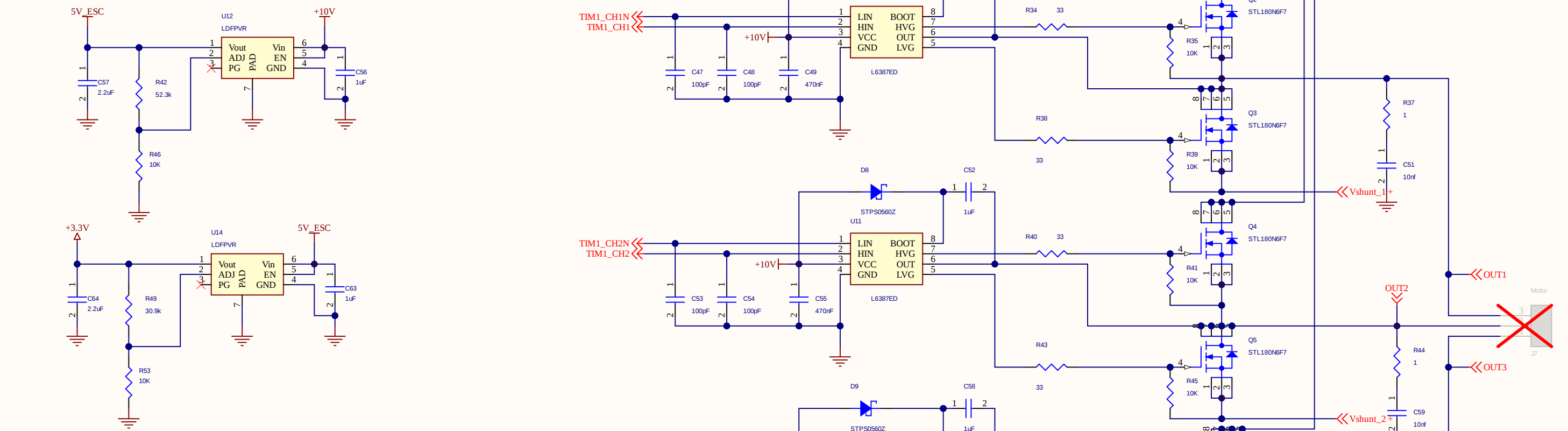
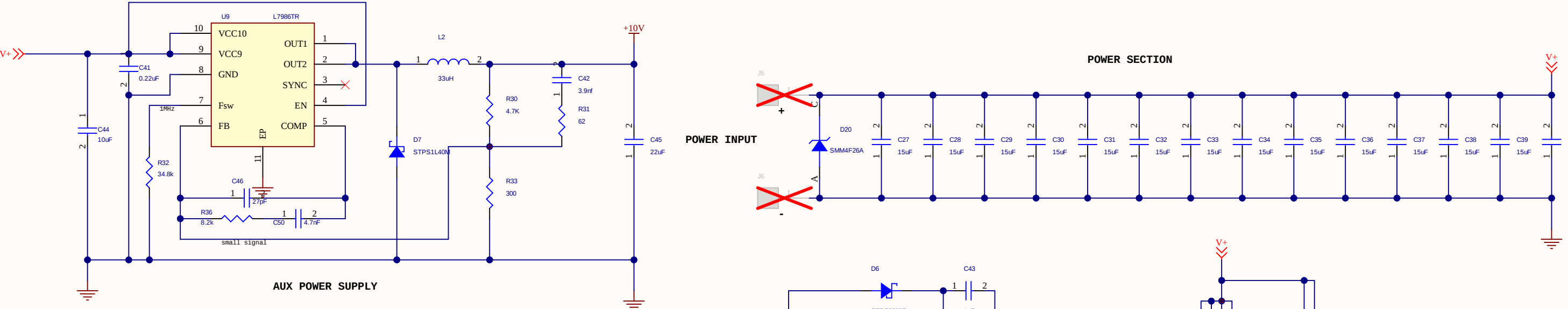
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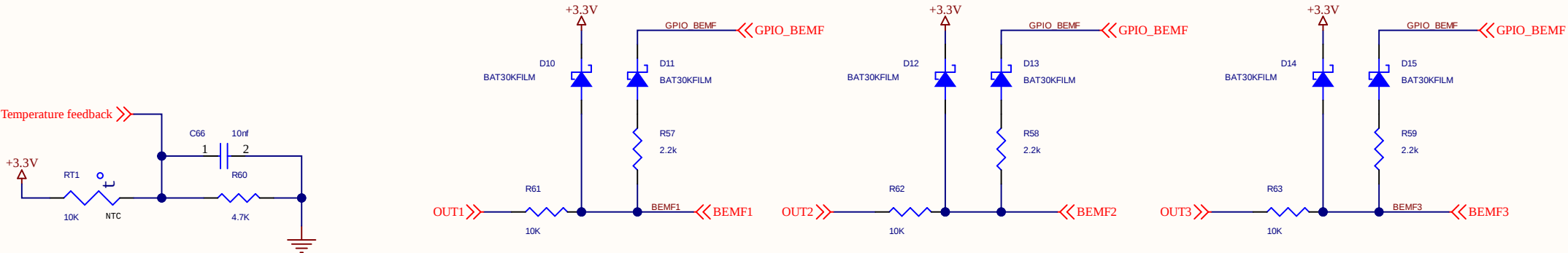


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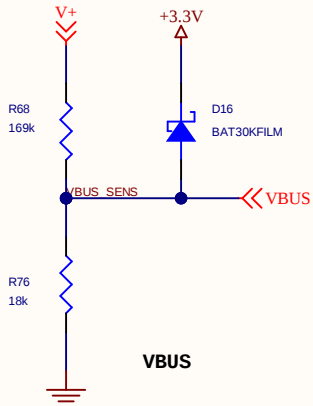
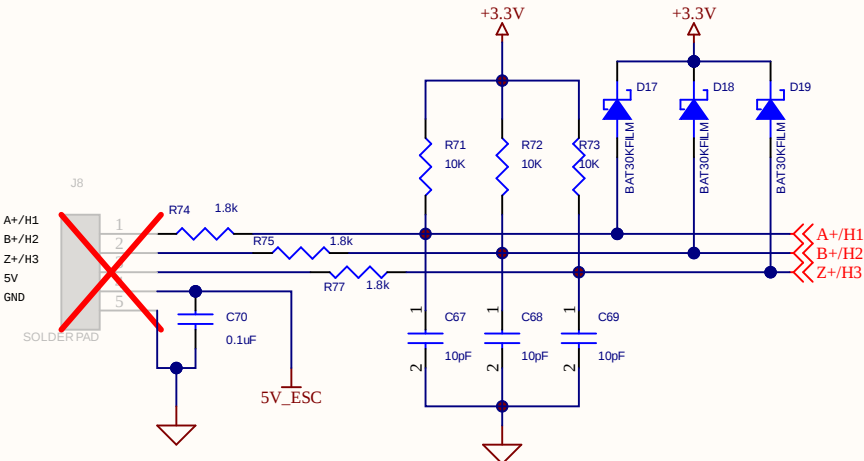


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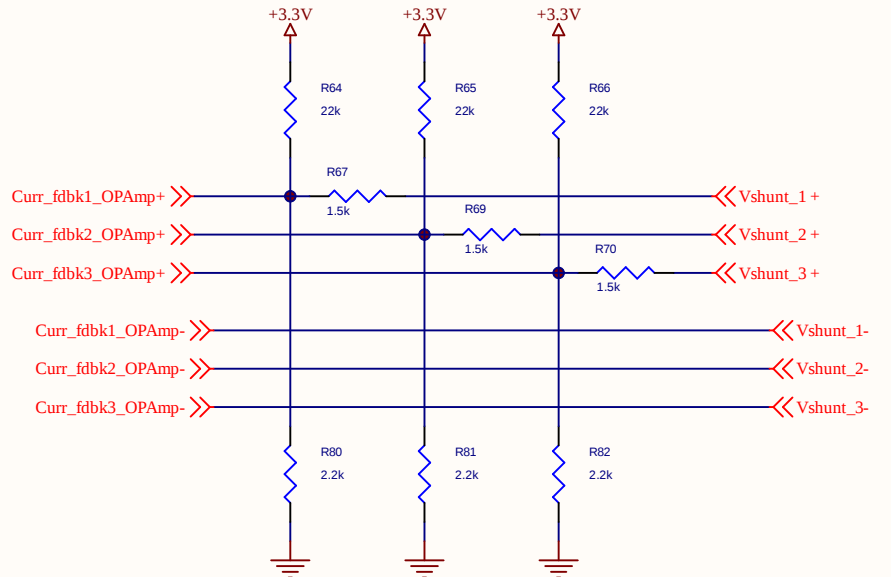
BEMF DETECTION- SIX STEP



HALL/ENCODER SENSOR

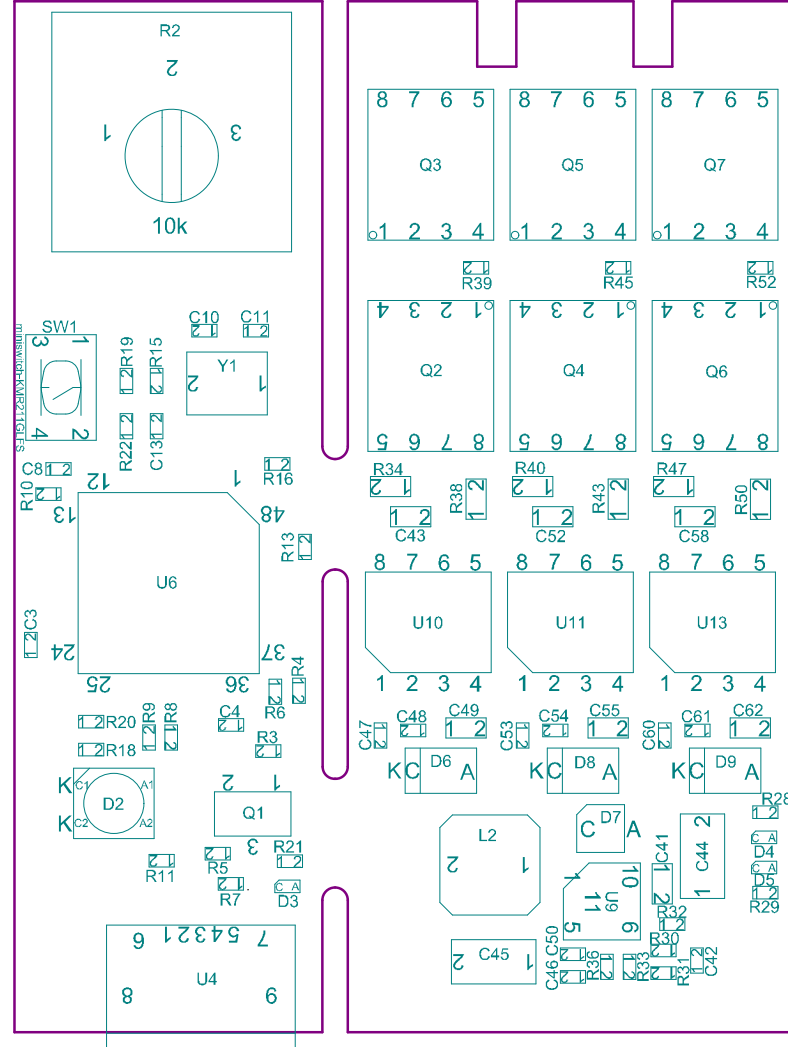


SHUNT SENSING CIRCUIT

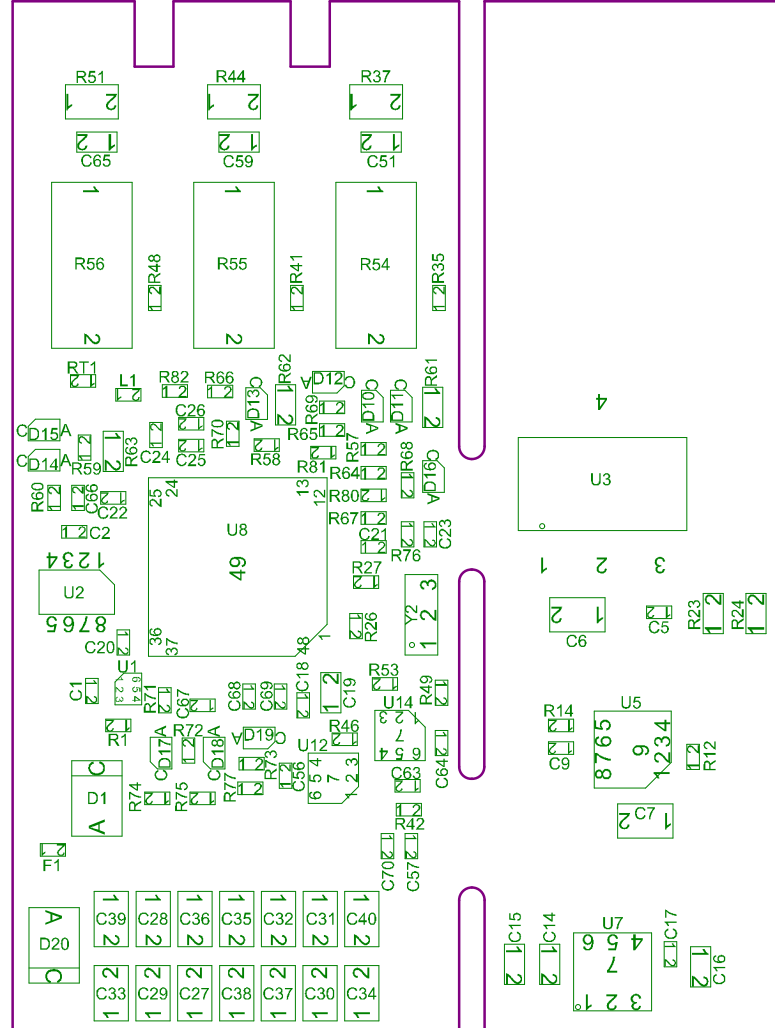


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Project: ESC_G4		
Layer: M14-Top Assembly	Gerber: .GM14	
Variant: G431CBU6	Ref: MB1419	
Date: 10-MAY-2020	Rev: B	



Project: ESC_G4	
Layer: M15-Bottom Assembly	Gerber: .GM15
Variant: G431CBU6	Ref: MB1419
Date: 10-MAY-2020	Rev: B

